EB1216 Series



REGULATORY COMPLIANCE						
Lead Free COMPLIANT	EU RoHS 2011/65 + 2015/863 COMPLIANT	China RoHS	REACH SVHC	DRC CONFLICT FREE		
ITEM DESCRIPTION						

Automotive Grade Quartz Crystal Resonator 1.2mm x 1.6mm x 0.4mm 4 Pad Ceramic Surface Mount (SMD)

ELECTRICAL SPECIFIC	ATIONS	
Nominal Frequency	24MHz to 50MHz	
Frequency Tolerance/Stability	±50ppm at 25°C, ±100ppm over -40°C to +85°C ±50ppm at 25°C, ±100ppm over -40°C to +105°C	
	±50ppm at 25°C, ±100ppm over -40°C to +125°C	
	±30ppm at 25°C, ±50ppm over -40°C to +85°C ±30ppm at 25°C, ±50ppm over -40°C to +105°C	
	± 30 ppm at 25°C, ± 50 ppm over -40°C to +125°C	
	±15ppm at 25°C, ±30ppm over -40°C to +85°C	
	±15ppm at 25°C, ±20ppm over -40°C to +85°C ±10ppm at 25°C, ±20ppm over -40°C to +85°C	
Aging at 25°C	±3ppm/year Maximum	
Load Capacitance	Series Resonant 8pF Parallel Resonant to 32pF Parallel Resonant	
Shunt Capacitance	5pF Maximum	
Equivalent Series Resistance	150 Ohms Maximum over Nominal Frequency of 24MHz to 39.999999MHz 100 Ohms Maximum over Nominal Frequency of 40MHz to 50MHz	
Mode of Operation	AT-Cut Fundamental	
Drive Level	100µWatts Maximum	
Spurious Response	sponse Measured from Fo to Fo +5000ppm -3dB Minimum	
Storage Temperature Range	-50°C to +150°C	
Insulation Resistance	Measured at 100Vdc 500 Megaohms Minimum	

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PART NUMBERING GUIDE

EB1216 X A 20 -48.000M TR

Series Automotive Quartz Crystal Resonator 1.2mm x 1.6mm x 0.4mm 4 Pad Ceramic Surface Mount (SMD)

Frequency Tolerance/Stability

- Frequency Tolerance/Stability C = ±50ppm at 25°C, ±100ppm over -40°C to +85°C J = ±13ppm at 25°C, ±50ppm over -40°C to +85°C M = ±15ppm at 25°C, ±20ppm over -40°C to +85°C Q = ±10ppm at 25°C, ±20ppm over -40°C to +85°C U = ±50ppm at 25°C, ±100ppm over -40°C to +105°C V = ±30ppm at 25°C, ±50ppm over -40°C to +105°C X = ±50ppm at 25°C, ±100ppm over -40°C to +125°C Y = ±30ppm at 25°C, ±50ppm over -40°C to +125°C

Packaging Options Blank = Bulk (Cut Tape) TR = Tape & Reel

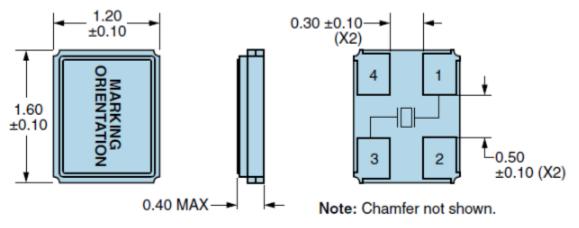
Nominal Frequency

Load Capacitance S = Series Resonant XX = 8pF Parallel Resonant to 32pF Parallel Resonant

Mode of Operation A = AT-Cut Fundamental



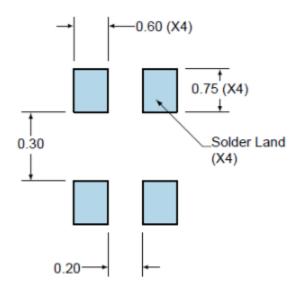
MECHANICAL DIMENSIONS



Seam Sealed

Terminal Plating Thickness: Gold (0.3 to 1.0µm) over Nickel (2.00 to 8.89µm).

SUGGESTED SOLDER PAD LAYOUT



PIN	CONNECTION
1	Crystal
2	Cover/Ground
3	Crystal
4	No Connect

All Tolerances are ±0.1

All Dimensions in Millimeters

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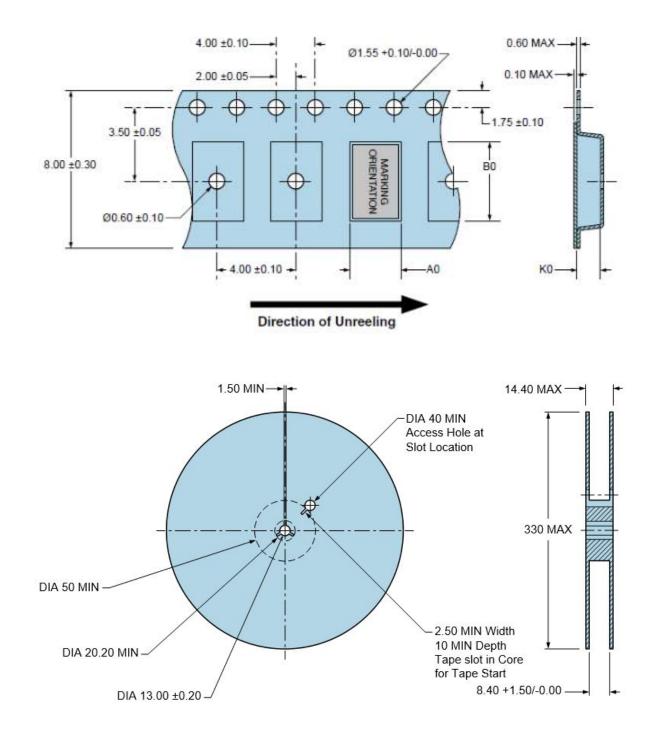


TAPE & REEL DIMENSIONS

Quantity per Reel: 3,000 Units

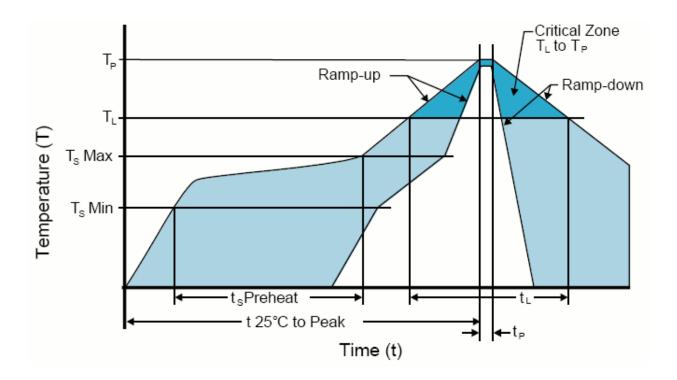
All Dimensions in Millimeters

Compliant to EIA-481





RECOMMENDED SOLDER REFLOW METHOD



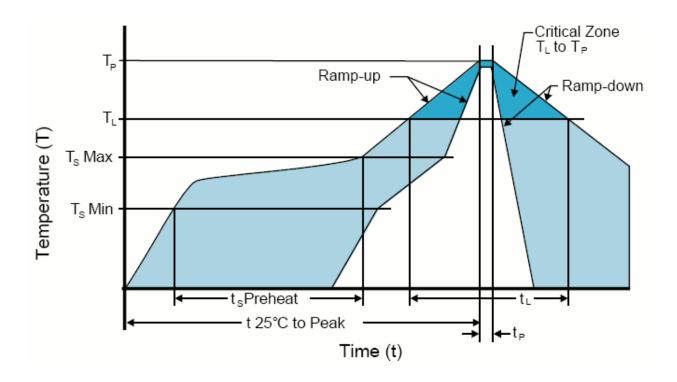
HIGH TEMPERATURE INFRARED/CONVECTION				
Ts MAX to T∟ (Ramp-up Rate)	3°C/Second Maximum			
Preheat				
- Temperature Minimum (Ts MIN)	150°C			
 Temperature Typical (Ts TYP) 	175°C			
 Temperature Maximum(Ts MAX) 	200°C 60 - 180 Seconds			
- Time (t _s)				
Ramp-up Rate (T⊾ to T _P)	3°C/Second Maximum			
Time Maintained Above:				
- Temperature (T∟)	217°C			
- Time (t∟)	60 - 150 Seconds			
Peak Temperature (T _P)	260°C Maximum for 10 Seconds Maximum			
Target Peak Temperature(T _P Target)	250°C +0/-5°C			
Time within 5°C of actual peak (t _p)	20 - 40 Seconds			
Ramp-down Rate	6°C/Second Maximum			
Time 25°C to Peak Temperature (t)	8 Minutes Maximum			
Moisture Sensitivity Level	Level 1			
Additional Notes	Temperatures shown are applied to body of device.			

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)



RECOMMENDED SOLDER REFLOW METHOD



LOW TEMPERATURE INFRARED/CONVECTION				
Ts MAX to T∟ (Ramp-up Rate)	5°C/Second Maximum			
Preheat				
 Temperature Minimum (T_s MIN) 	N/A			
 Temperature Typical (T_s TYP) 	150°C			
 Temperature Maximum(T_s MAX) 	N/A			
- Time (t _s)	30 - 60 Seconds			
Ramp-up Rate (T⊾ to T _P)	5°C/Second Maximum			
Time Maintained Above:				
- Temperature (T∟)	150°C			
- Time (t∟)	200 Seconds Maximum			
Peak Temperature (T _P)	245°C Maximum			
Target Peak Temperature (T _P Target)	245°C Maximum 2 Times / 230°C Maximum 1 Time			
Time within 5°C of actual peak (t _p)	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time			
Ramp-down Rate	5°C/Second Maximum			
Time 25°C to Peak Temperature (t)	N/A			
Moisture Sensitivity Level	Level 1			
Additional Notes	Temperatures shown are applied to body of device.			

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)